

# SKKT 20, SKKT 20B



**SEMIPACK® 1**

## Thyristor / Diode Modules

**SKKT 20**  
**SKKT 20B**

### Features

- Heat transfer through aluminium oxide ceramic isolated metal baseplate
- Hard soldered joints for high reliability
- UL recognized, file no. E 63 532

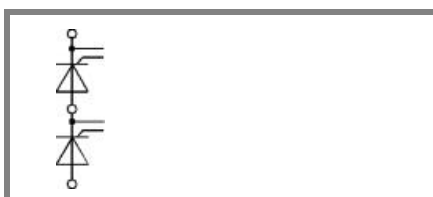
### Typical Applications

- DC motor control (e. g. for machine tools)
- AC motor soft starters
- Temperature control (e. g. for ovens, chemical processes)
- Professional light dimming (studios, theaters)

1) See the assembly instructions

| $V_{RSM}$<br>V | $V_{RRM}, V_{DRM}$<br>V | $I_{TRMS} = 40$ A (maximum value for continuous operation) |             |
|----------------|-------------------------|--|-------------|
|                |                         | $I_{TAV} = 20$ A (sin. 180; $T_c = 80$ °C)                 |             |
| 900            | 800                     | SKKT 20/08E  | SKKT 20B08E |
| 1300           | 1200                    | SKKT 20/12E  | SKKT 20B12E |
| 1500           | 1400                    | SKKT 20/14E  | SKKT 20B14E |
| 1700           | 1600                    | SKKT 20/16E  | SKKT 20B16E |

| Symbol           | Conditions  | Values                 | Units |
|------------------|---|------------------------|-------|
| $I_{TAV}$        | sin. 180; $T_c = 85$ (100) °C;                          | 18 (13)                | A     |
| $I_D$            | P3/180; $T_a = 45$ °C; B2 / B6                          | 31 / 38                | A     |
|                  | P3/180F; $T_a = 35$ °C; B2 / B6                         | 46 / 60                | A     |
| $I_{RMS}$        | P3/180; $T_a = 45$ °C; W1 / W3                          | 42 / 3 * 30            | A     |
| $I_{TSM}$        | $T_{vj} = 25$ °C; 10 ms                                 | 320                    | A     |
|                  | $T_{vj} = 125$ °C; 10 ms                                | 280                    | A     |
| $i^2t$           | $T_{vj} = 25$ °C; 8,3 ... 10 ms                         | 510                    | A²s   |
|                  | $T_{vj} = 125$ °C; 8,3 ... 10 ms                        | 390                    | A²s   |
| $V_T$            | $T_{vj} = 25$ °C; $I_T = 75$ A                          | max. 2,3               | V     |
| $V_{T(TO)}$      | $T_{vj} = 125$ °C                                       | max. 1                 | V     |
| $r_T$            | $T_{vj} = 125$ °C                                       | max. 16                | mΩ    |
| $I_{DD}, I_{RD}$ | $T_{vj} = 125$ °C; $V_{RD} = V_{RRM}, V_{DD} = V_{DRM}$ | max. 10                | mA    |
| $t_{gd}$         | $T_{vj} = 25$ °C; $I_G = 1$ A; $di_G/dt = 1$ A/μs       | 1                      | μs    |
| $t_{gr}$         | $V_D = 0,67 * V_{DRM}$                                  | 1                      | μs    |
| $(di/dt)_{cr}$   | $T_{vj} = 125$ °C                                       | max. 150               | A/μs  |
| $(dv/dt)_{cr}$   | $T_{vj} = 125$ °C                                       | max. 1000              | V/μs  |
| $t_q$            | $T_{vj} = 125$ °C                                       | 80                     | μs    |
| $I_H$            | $T_{vj} = 25$ °C; typ. / max.                           | 100 / 200              | mA    |
| $I_L$            | $T_{vj} = 25$ °C; $R_G = 33$ Ω; typ. / max.             | 250 / 400              | mA    |
| $V_{GT}$         | $T_{vj} = 25$ °C; d.c.                                  | min. 3                 | V     |
| $I_{GT}$         | $T_{vj} = 25$ °C; d.c.                                  | min. 150               | mA    |
| $V_{GD}$         | $T_{vj} = 125$ °C; d.c.                                 | max. 0,25              | V     |
| $I_{GD}$         | $T_{vj} = 125$ °C; d.c.                                 | max. 5                 | mA    |
| $R_{th(j-c)}$    | cont.; per thyristor / per module                       | 1,2 / 0,6              | K/W   |
| $R_{th(j-c)}$    | sin. 180; per thyristor / per module                    | 1,3 / 0,65             | K/W   |
| $R_{th(j-c)}$    | rec. 120; per thyristor / per module                    | 1,35 / 0,68            | K/W   |
| $R_{th(c-s)}$    | per thyristor / per module                              | 0,2 / 0,1              | K/W   |
| $T_{vj}$         |   | - 40 ... + 125         | °C    |
| $T_{stg}$        |   | - 40 ... + 125         | °C    |
| $V_{isol}$       | a. c. 50 Hz; r.m.s.; 1 s / 1 min.                       | 3600 / 3000            | V~    |
| $M_s$            | to heatsink   | 5 ± 15 % <sup>1)</sup> | Nm    |
| $M_t$            | to terminal   | 3 ± 15 %               | Nm    |
| $a$              |   | 5 * 9,81               | m/s²  |
| $m$              | approx.   | 95                     | g     |
| Case             | SKKT  | A 46                   |       |
|                  | SKKT ...B   | A 48                   |       |



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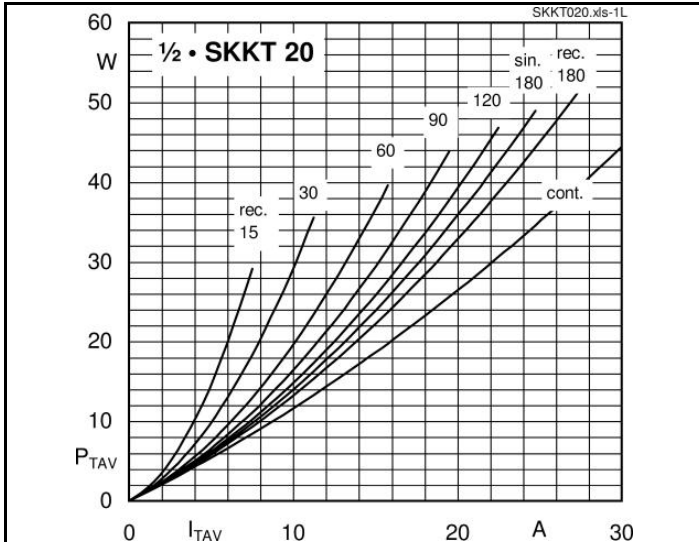


Fig. 1L Power dissipation per thyristor vs. on-state current

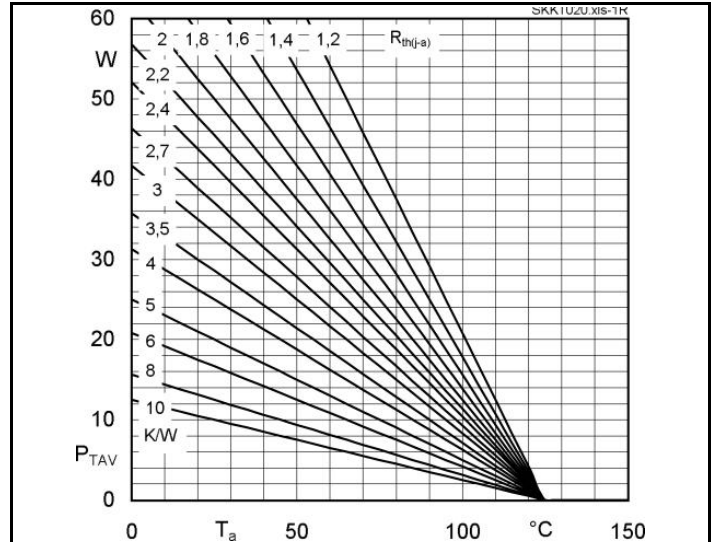


Fig. 1R Power dissipation per thyristor vs. ambient temp.

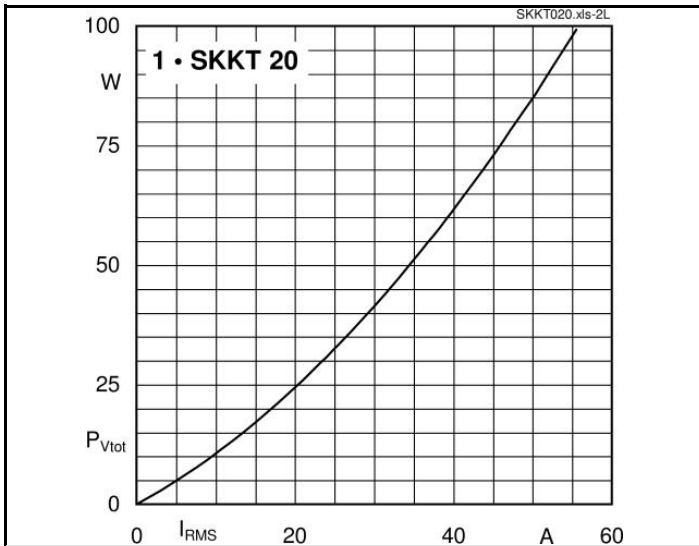


Fig. 2L Power dissipation per module vs. rms current

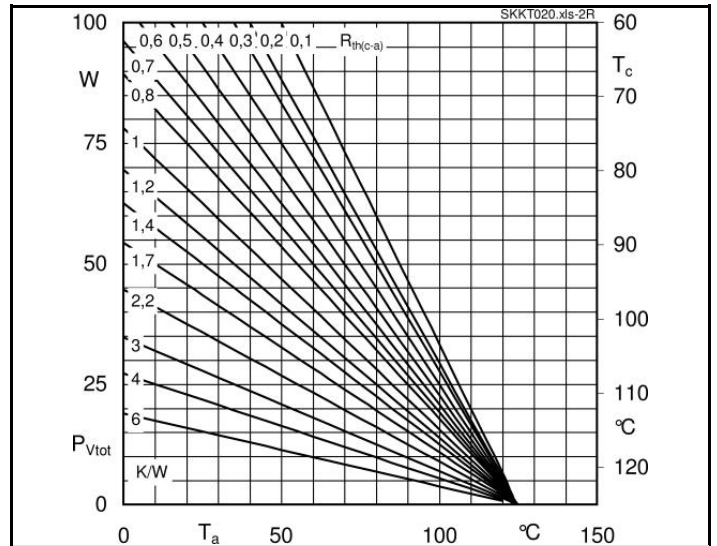


Fig. 2R Power dissipation per module vs. case temp.

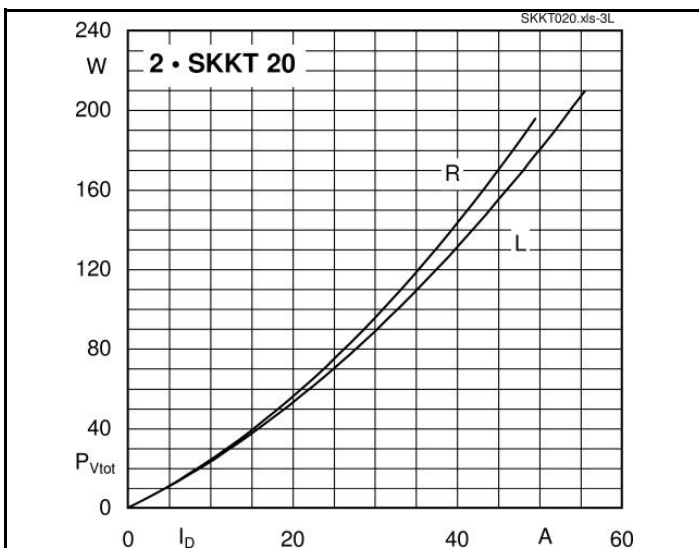


Fig. 3L Power dissipation of two modules vs. direct current

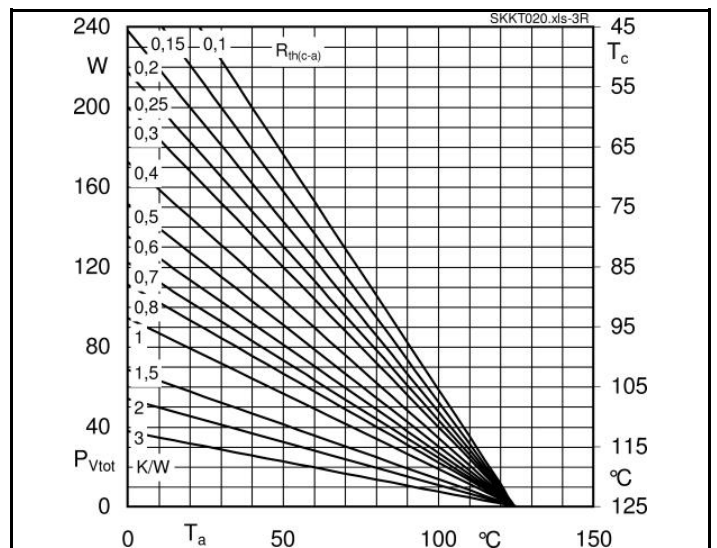
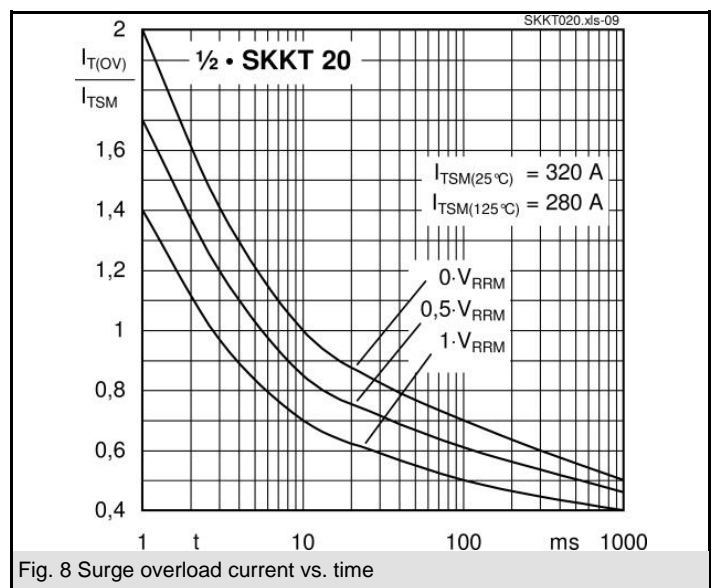
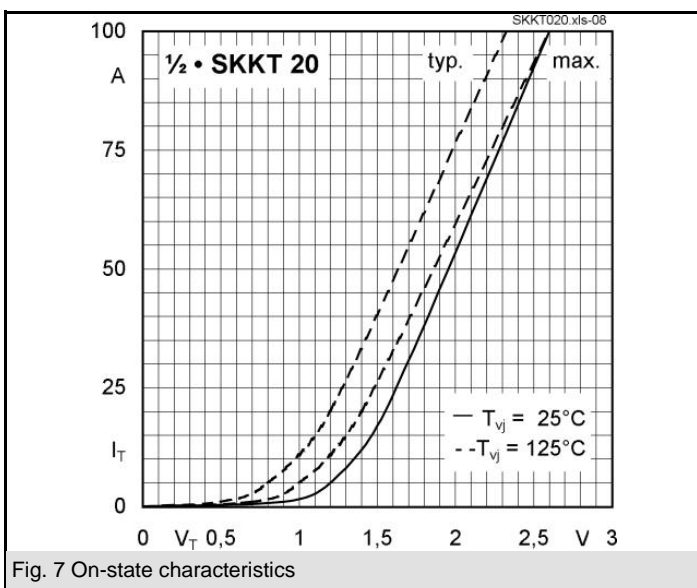
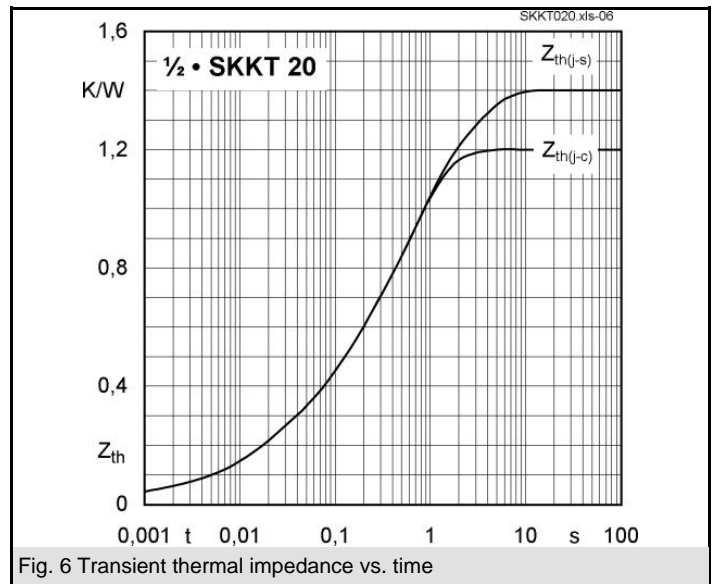
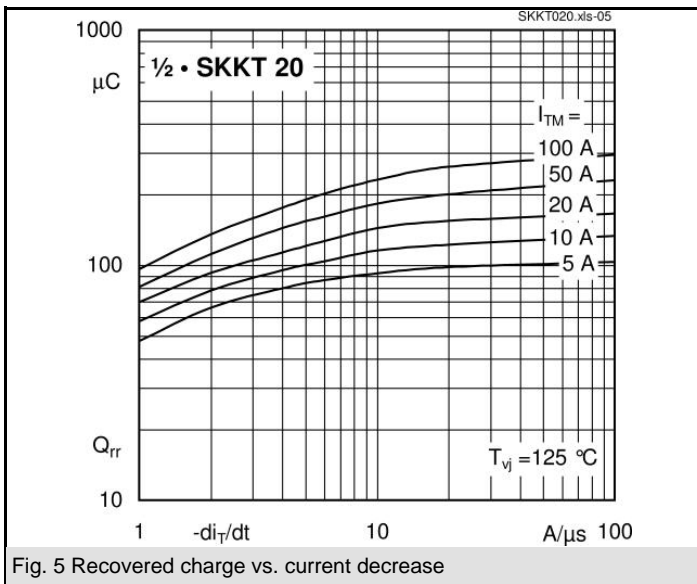
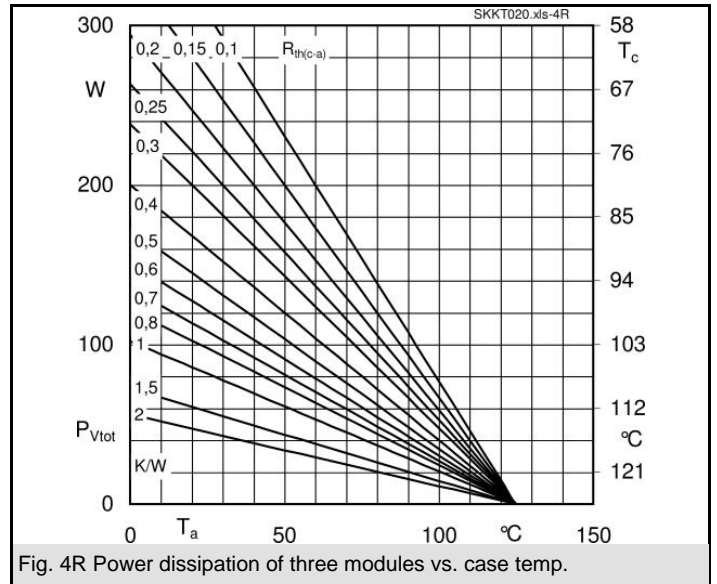
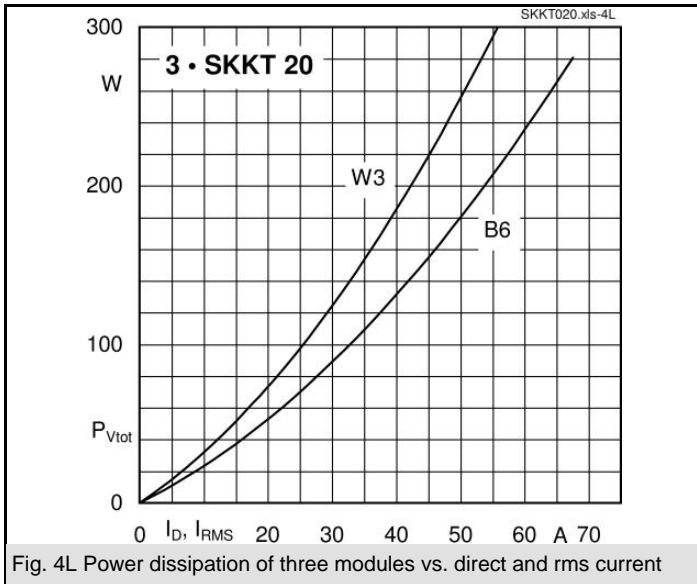
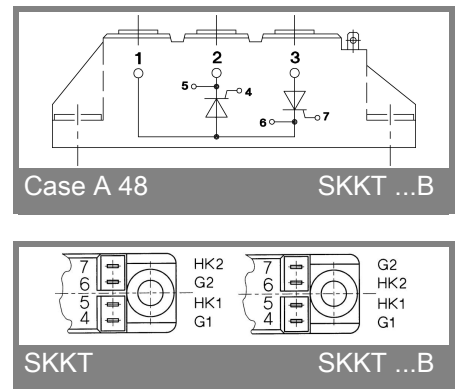
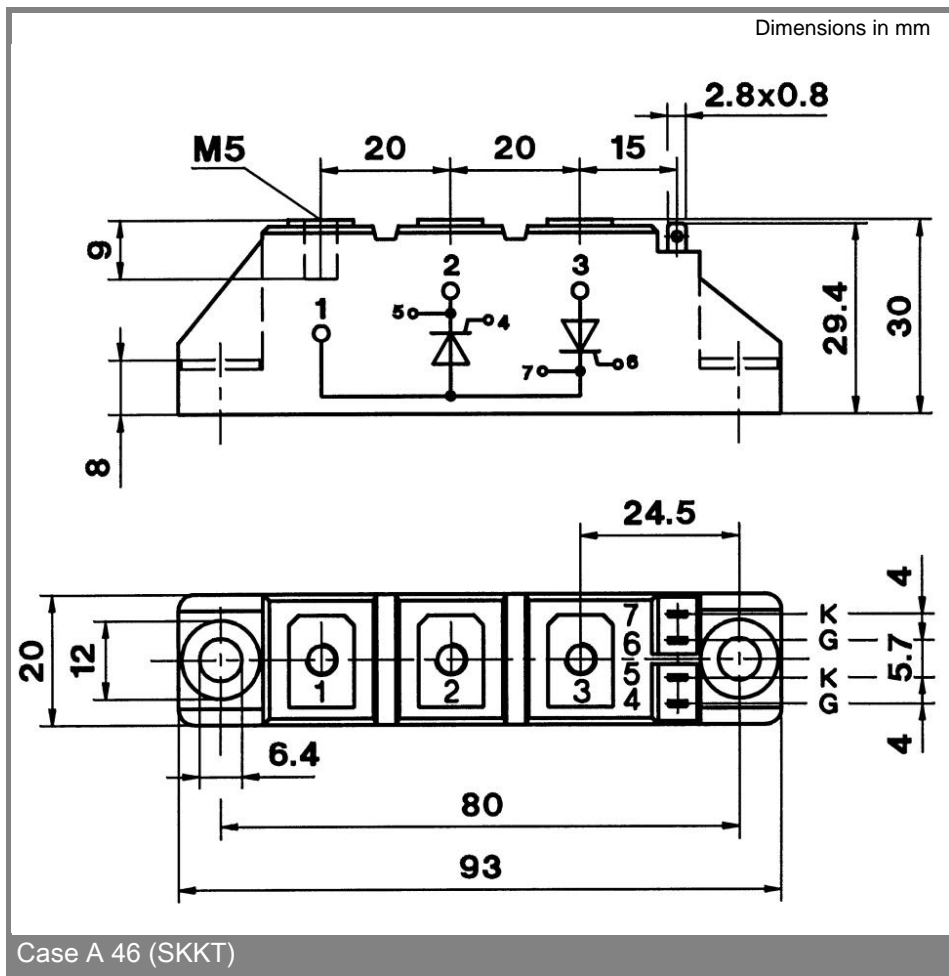
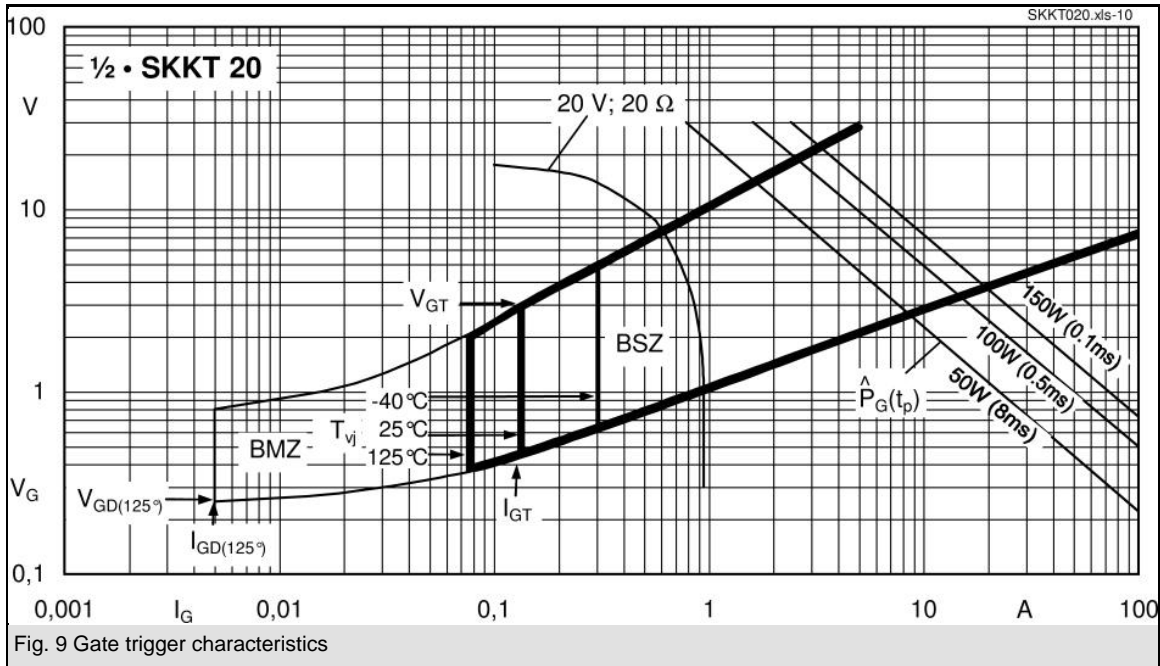


Fig. 3R Power dissipation of two modules vs. case temp.

# SKKT 20, SKKT 20B





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